RU80N15R-VB TO220



RU80N15R-VB TO220 Datasheet

N-Channel 150-V (D-S) 175 °C MOSFET

PRODUCT	PRODUCT SUMMARY			
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)		
150	0.0175 at V _{GS} = 10 V	70		

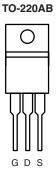
FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature

APPLICATIONS

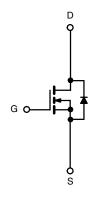
• Primary Side Switch





Top View

DRAIN connected to TAB



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	150	v	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	1-	70		
	T _C = 125 °C	I _D	50	A	
Pulsed Drain Current		I _{DM}	180	^	
Avalanche Current		I _{AS}	50	1	
Single Pulse Avalanche Energy ^b	L = 0.1 mH	E _{AS}	125	mJ	
	T _C = 25 °C	Р	300 ^c		
Maximum Power Dissipation ^b	T _A = 25 °C ^d	• P _D —	2.4	W	
Operating Junction and Storage Temperature Range	L	T _J , T _{stq}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient-Free Air	R _{thJA}	62.5	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.4	C/W	

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	150			v
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 120 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
	I _{DSS}	V_{DS} = 120 V, V_{GS} = 0 V, T_{J} = 125 °C			50	
		$V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			Α
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 30 A		0.0175		
	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.042		Ω
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.055		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S
Dynamic ^b	•	·				
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		4750		pF
Output Capacitance	C _{oss}			530		
Reverse Transfer Capacitance	C _{rss}			220		
Total Gate Charge ^c	Qg			76	110	nC
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 75 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 85 \text{ A}$		21		
Gate-Drain Charge ^c	Q _{gd}			26		
Turn-On Delay Time ^c	t _{d(on)}			22	35	- ns
Rise Time ^c	t _r	V_{DD} = 75 V, R _L = 0.9 Ω I _D \cong 85 A, V _{GEN} = 10 V, R _G = 2.5 Ω		170	250	
Turn-Off Delay Time ^c	t _{d(off)}			40	60	
Fall Time ^c	t _f			170	250	
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b				
Continuous Current	۱ _S				70	A
Pulsed Current	I _{SM}				180	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	Α
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

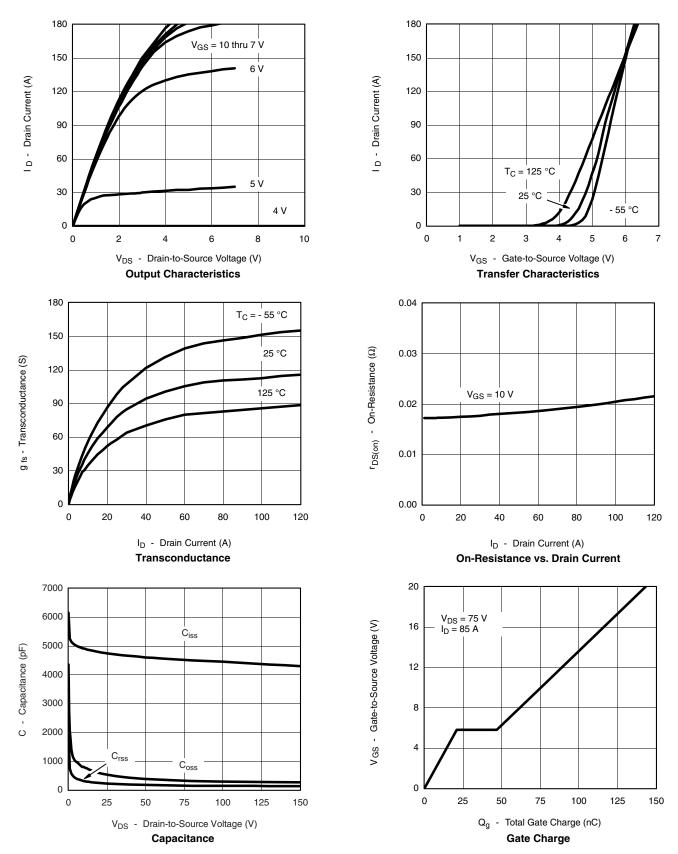
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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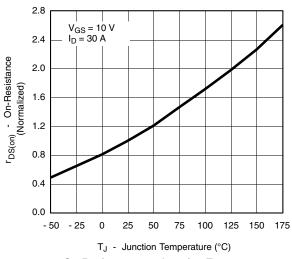


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

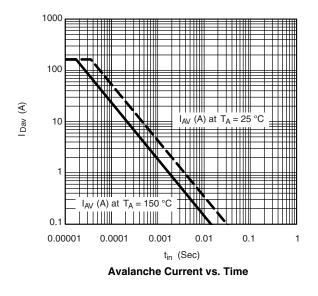


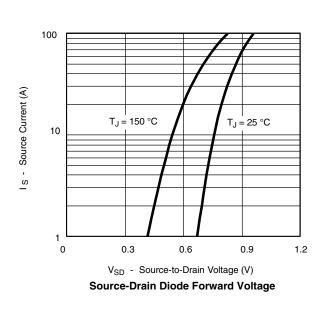


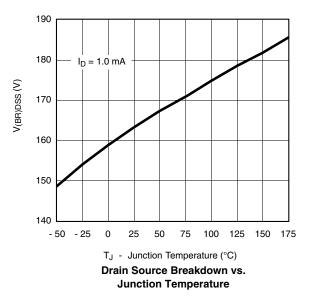
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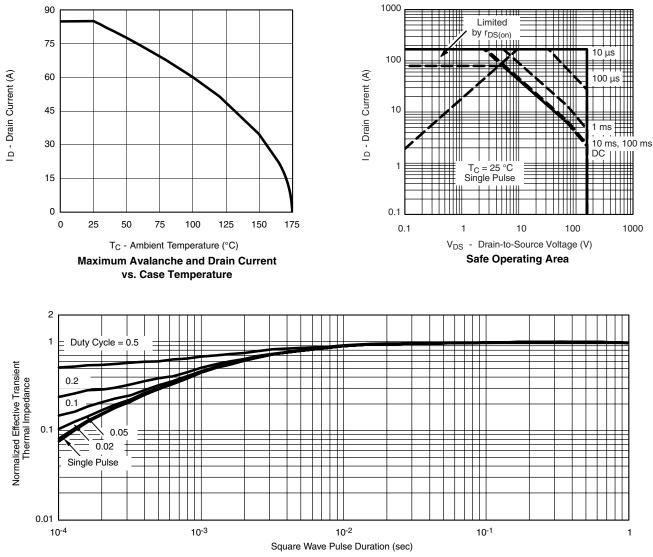


服务热线:400-655-8788

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THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



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